Yi Chien (Jason) Lin

yichienl@usc.edu

in jasonlin316 p jasonlin316.github.io p jasonlin316

RESEARCH

FPGA/PARALLEL COMPUTING LAB | GRADUATE RESEARCHER

Sept. 2020 - Present | Los Angeles, CA

Worked with Professor Prasanna on hardware acceleration of Graph Neural Networks inference and training on heterogeneous platform.

DATA PROCESSING SYSTEM LAB | UNDERGRADUATE RESEARCHER

Sept. 2018 - July. 2020 | Taipei, Taiwan

Worked with Professor Yi-Chang Lu on hardware accelerator for DNA sequence alignment.

- Designed Application-Specific Integrated Circuit (ASIC) for sequence alignment with two-piece affine gap tracebacks.
- Implemented Smith-Waterman algorithm using systolic array. [Link]

MICRO SYSTEM RESEARCH LAB | UNDERGRADUATE RESEARCHER

July. 2019 – Jan. 2020 | Taipei, Taiwan

Worked with **Professor Tzi-Dar Chiueh** on digital circuit design.

- Taped-out a 5 stage pipelined RISC-V CPU on a 1.5mm × 1.5mm chip with 180nm technology. [Link]
- Perform the entire IC design flow, from design to synthesis, place & route, verification and tape-out.

PUBLICATION & PATENTS

- [1] Yi-Chien Lin, Bingyi Zhang, and Viktor Prasanna. HP-GNN: Generating High Throughput GNN Training Implementation on CPU-FPGA Heterogeneous Platform. In ACM International Symposium on Field-Programmable Gate Arrays (FPGA), 2022.
- [2] Yi-Chien Lin, Bingyi Zhang, and Viktor Prasanna. Gcn Inference Acceleration Using High-level Synthesis. In IEEE High Performance Extreme Computing Conference (HPEC), 2021.
- [3] Yi-Chien Lin, Chih hung Lin, Ling-Yu Wu, and Chih shiuan Lee. Face Orientation-based Cursor Positioning on Display Screens. In US Patent WO/2021/145855, 2021.
- [4] Jing-Ping Wu, Yi-Chien Lin, Ying-Wei Wu, Shih-Wei Hsieh, Ching-Hsuan Tai, and Yi-Chang Lu. A Memory-efficient Accelerator for Dna Sequence Alignment with Two-piece Affine Gap Tracebacks. In IEEE International Symposium on Circuits and Systems (ISCAS), 2021.

EDUCATION

UNIVERSITY OF SOUTHERN CALIFORNIA | PHD IN ELECTRICAL ENGINEERING

Sept. 2020 - Present | Los Angeles, CA · Cum. GPA: 3.95/4.0

NATIONAL TAIWAN UNIVERSITY | BS IN ELECTRICAL ENGINEERING

Sept. 2016 - June. 2020 | Taipei, Taiwan · Cum. GPA: 3.75/4.3

WORK EXPERIENCE & SERVICES

REVIEWER FPGA '22, SC '21, HPEC '21.

2020 - Present

HEWLETT & PACKARD INC.(HP) | ELECTRICAL ENGINEERING R&D INTERN AT COMMERCIAL NOTEBOOK TEAM July. 2019 - July. 2020 | Taipei, Taiwan

- Developed a software that could enhance efficiency of cursor movement. Idea has been patented by HP.
- Developed a system that provides users with different preference settings based on different scenario.

AWARDS

VITERBI SCHOOL OF ENGINEERING FELLOWSHIP

Los Angeles, CA. 2020

NTUEE UNDERGRADUATE INNOVATION AWARD THIRD PRIZE

Taipei, Taiwan. 2019

LANGUAGES

PROGRAMMING

Verilog/SystemVerilog • High-Level Synthesis • C/C++ • Python

TOOLS

Xilinx Vitis • Cadence NC-Verilog • Synopsis Design Compiler • Cadence Innovous

ENGLISH

GRE: V:154, Q:169, AW:3.5 TOEFL:108 R:29, L:29, W:27, S:23